



July 12, 2023

Ms. Susanna Kooistra
Mr. Juha Korhonen
3GPP Mobile Competence Centre (ETSI)
650, Route Des Lucioles
06921 Sophia-Antipolis
France

Subject: Nomination of Mr. Yi Guo as a candidate for 3GPP TSG RAN WG2 Vice Chair

Dear Susanna, Dear Juha,

On behalf of Intel (ATIS member), I am pleased to nominate Mr. Yi Guo as a candidate for the position of 3GPP TSG RAN WG2 Vice Chair.

Mr. Yi Guo has worked in 3GPP for more than 20 years, through which he has gained deep technical knowledge of the radio access network and protocols across LTE and NR, from control plane to user plane, and from PHY layer to Core Network. Having worked for companies involved in different sectors of the industry, he has versatile experiences of 3GPP standardization from both network and device perspectives. He has actively contributed to 3GPP by working as Specification Rapporteur (TS36.314, TS38.355), and Work/Study Item Rapporteur of multiple 3GPP RAN WIs (NR mobility enhancements, NR positioning, Voice and Video enhancement for LTE and LTE connectivity to 5G-CN), and he is currently working as a session chair for the Rel-18 In-Device Coexistence (IDC) WI in RAN WG2. With his technical expertise, background, and proven leadership record in 3GPP, Intel is confident that he will be an extraordinary RAN WG2 Vice Chairman. His brief Curriculum Vitae is attached.

Mr. Yi Guo is informed about and aware of the antitrust/competition laws and regulations of relevant jurisdictions, and will comply with such laws while acting in his capacity as 3GPP TSG RAN WG2 Vice Chair.

Intel is fully committed to the success of 3GPP and its diverse ecosystem. Thus, Intel will fully support and provide the necessary resources to ensure that Mr. Yi Guo accomplishes the duties and carries out his responsibilities as the Vice Chair of 3GPP TSG RAN WG2.

Yours sincerely,

A handwritten signature in black ink, appearing to read "Wu Geng", written in a cursive style.

Geng Wu
Intel Fellow and Head of Wireless Standards
Next Generation and Standards (NGS), Intel



Position of candidacy: 3GPP TSG RAN WG2 Vice Chair

Candidate Name: Yi Guo

Member: Intel

Partner Organization: ATIS

Brief Curriculum Vitae:

Mr. Yi Guo is a Principal Engineer in the Next Generation and Standards (NGS) Group at Intel Corporation. He joined Intel in October of 2017 and is working as a technical lead coordinating NR Rel-18 /19. Prior to Intel, he worked in Datang mobile from 2003 to 2007 as a researcher for core-network and RNC of 3G system, and then worked in Huawei from 2007 to 2017 as different roles (internal co-ordinator with product, RAN2 co-prime).

He has worked in 3GPP for more than 20 years and has deep technical understanding of the radio access network and protocols across LTE and NR. He has actively contributed to 3GPP by working as Specification Rapporteur (TS36.314, TS38.355), and Work/Study Item Rapporteur of multiple 3GPP RAN WIs (NR mobility enhancements, NR positioning, Voice and Video enhancement for LTE and LTE connectivity to 5G-CN), and he is currently working as a session chair for the Rel-18 In-Device Coexistence (IDC) WI in RAN WG2. As WI Rapporteur, session Chair, he is always try to help the group to come to conclusions on controversial topics/issues, e.g. R16 mobility enhancements.

He received the M.S. degree in Communication and Information System from Northwestern Polytechnical University, Xi'an, China (2000-2003).